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## Product Summary

$V_{RRM}$ (V)	$I_O$ (A)	$V_F$ (MAX) (V) @ +25°C	$I_R$ (MAX) (mA) @ +25°C
40	3	0.5	0.5

## Description

The APD340 is a low voltage dual Schottky rectifier suited for switch mode power supplies and other power converters. This device is intended for use in medium voltage operation, and particularly, in high frequency circuits where low switching losses and low noise are required.

The APD340 is available in standard DO-214AC package.


## Applications

- Low Voltage High Frequency Inverters
- DC-DC Converters
- Free Wheeling
- Polarity Protection

## Features

- Low Forward Voltage: 0.5V @ +25°C
- High Surge Current Capacity
- +125°C Operating Junction Temperature
- 3A Total
- Guard-Ring for Stress Protection
- Pb-free Package is Available
- Available in "Green" Packages: DO-214AC
  - **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
  - **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

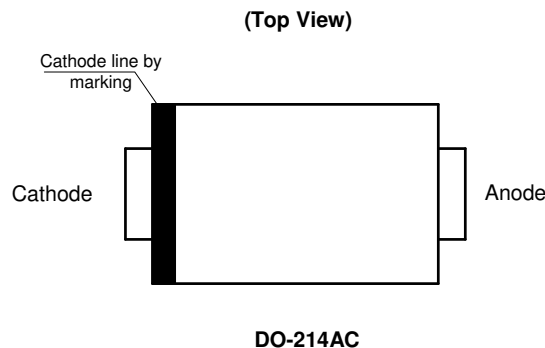
- Case: DO-214AC
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 
- Weight: DO-214AC – 0.062Grams (Approximately)



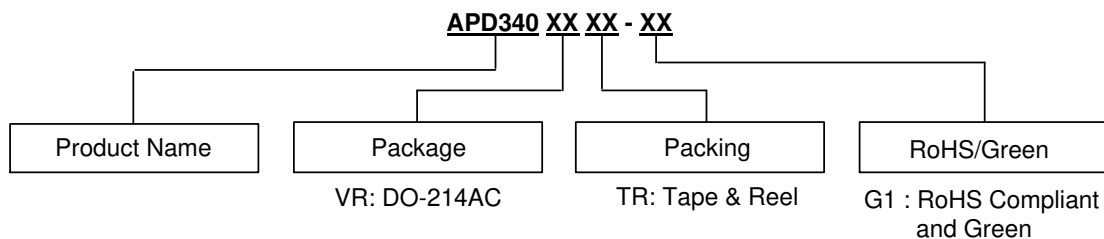
**DO-214AC**

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Pin Assignments



## Ordering Information



Package	Temperature Range	Part Number	Marking ID	Packing
DO-214AC	-50 to +125°C	APD340VRTR-G1	340VRG	7500/Tape & Reel

## Marking Information

(1) DO-214AC

(Top View)



First Line: Logo and Date Code  
 Y: Year  
 WW: Work Week of Molding  
 A: Assembly House Code  
 Second Line: Marking ID  
 (See Ordering Information)

## Maximum Ratings (T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 4)

Characteristic	Symbol	Rating	Unit
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	40	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	40	V
Maximum RMS Voltage	V <sub>RMS</sub>	28	V
Average Rectified Forward Current 0.375" (9.5mm) Lead Length	I <sub>F(AV)</sub>	3.0	A
Non-repetitive Peak Forward Surge Current 8.3ms Single Half Sine-wave on Rated Load	I <sub>FSM</sub>	80	A
Operating Junction Temperature Range (Note 5)	T <sub>J</sub>	-50 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-50 to +150	°C

Notes: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

5. The heat generated must be less than the thermal conductivity from Junction to Ambient:  $dP_D/dT_J < 1/\theta_{JA}$ .

## Thermal Characteristics (T<sub>A</sub> = +25°C, unless otherwise noted.)

Characteristic	Symbol	Rating		Unit
Typical Thermal Resistance (Note 6)	R <sub>θJA</sub>	DO-214AC	75	°C/W

Note 6: Device mounted on heat sink, with minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.

## Electrical Characteristics (T<sub>A</sub> = +25°C, unless otherwise noted.)

Characteristic	Symbol	Rating	Unit	Test Condition
Forward Voltage @ I <sub>F</sub> = 3.0A	V <sub>F</sub>	0.5	V	—
Reverse Current @ Rated V <sub>R</sub> (Note 7)	I <sub>R</sub>	0.5	mA	T <sub>A</sub> = +25°C
		10		T <sub>A</sub> = +100°C

Note 7: Short duration pulse test used to minimize self-heating effect, Pulse Test: 300μs pulse width, 1.0% duty cycle.



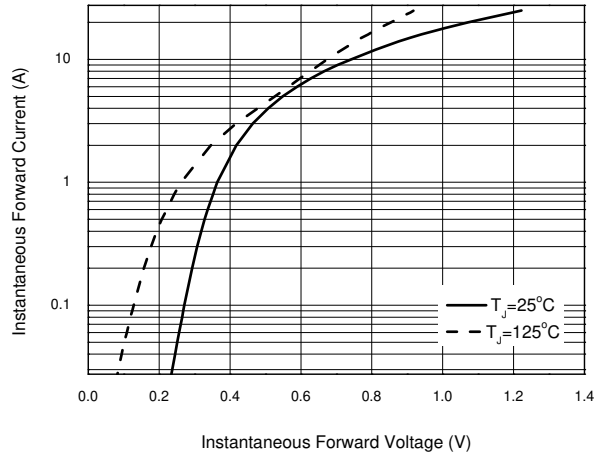


Figure 1. Typical Instantaneous Forward Characteristics

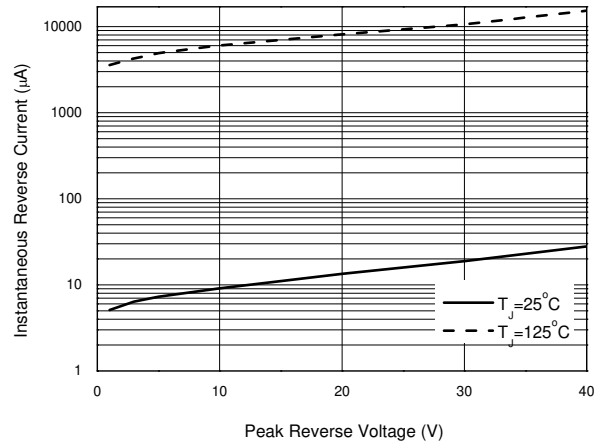


Figure 2. Typical Reverse Characteristics

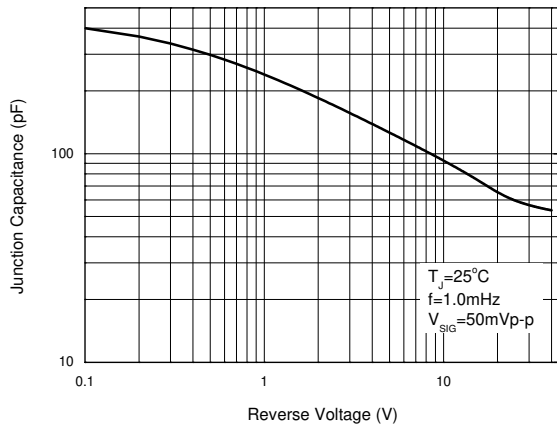


Figure 3. Typical Junction Capacitance

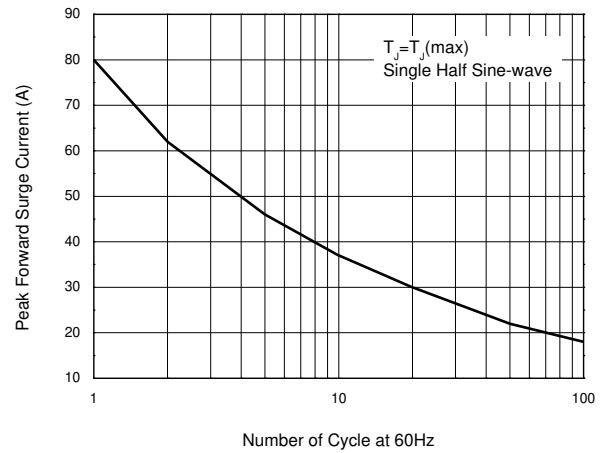


Figure 4. Maximum Non-Repetitive Peak Forward Surge Current

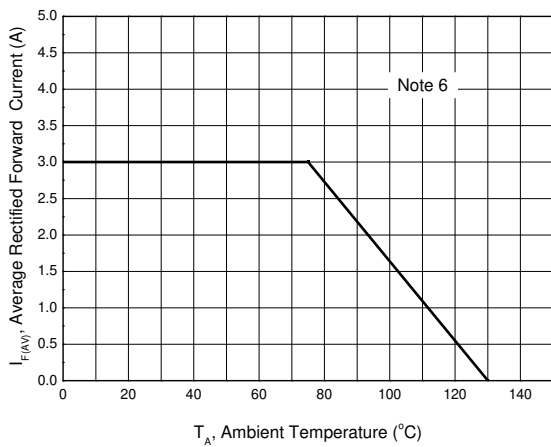
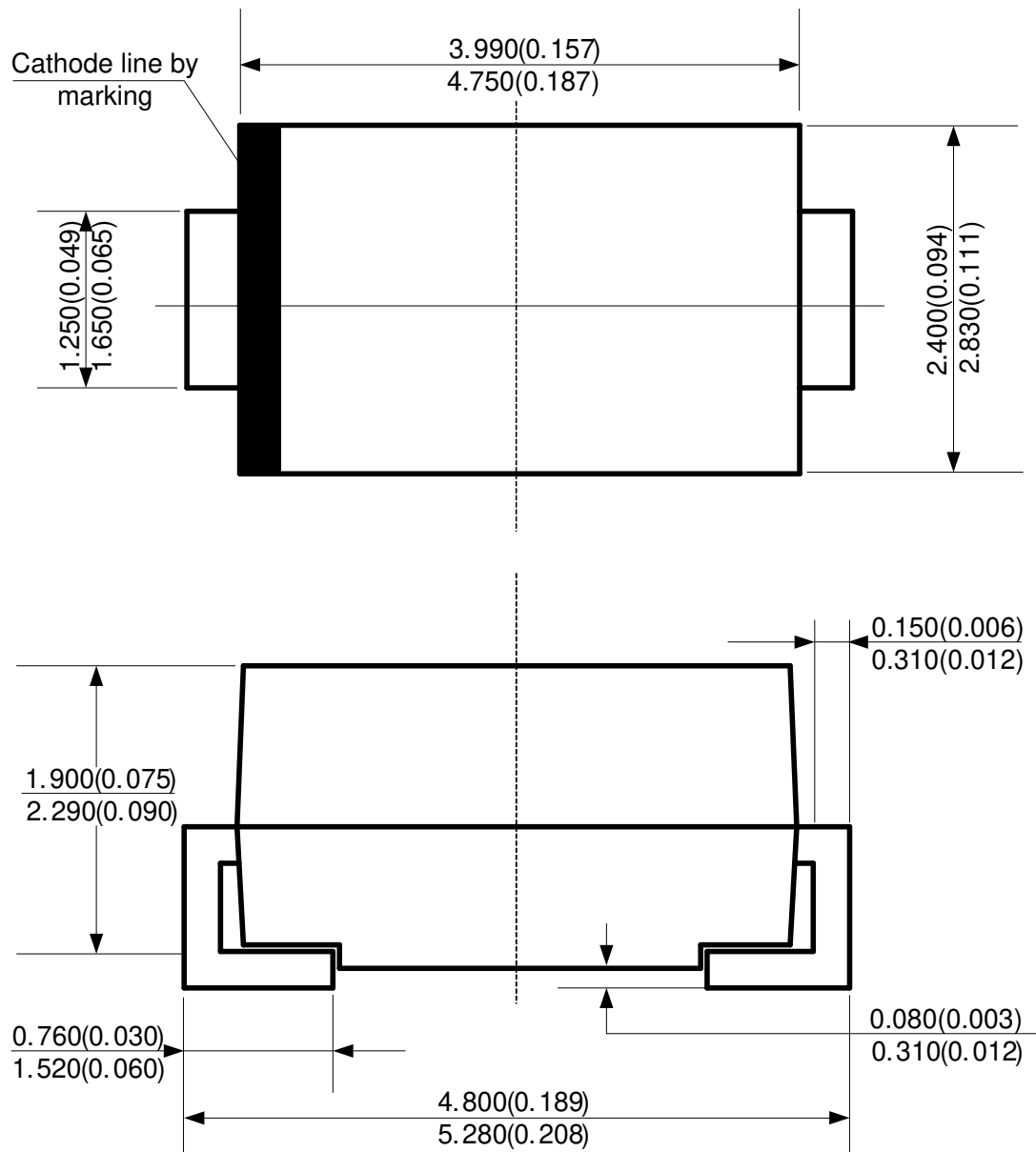


Figure 5. Forward Current Derating Curves

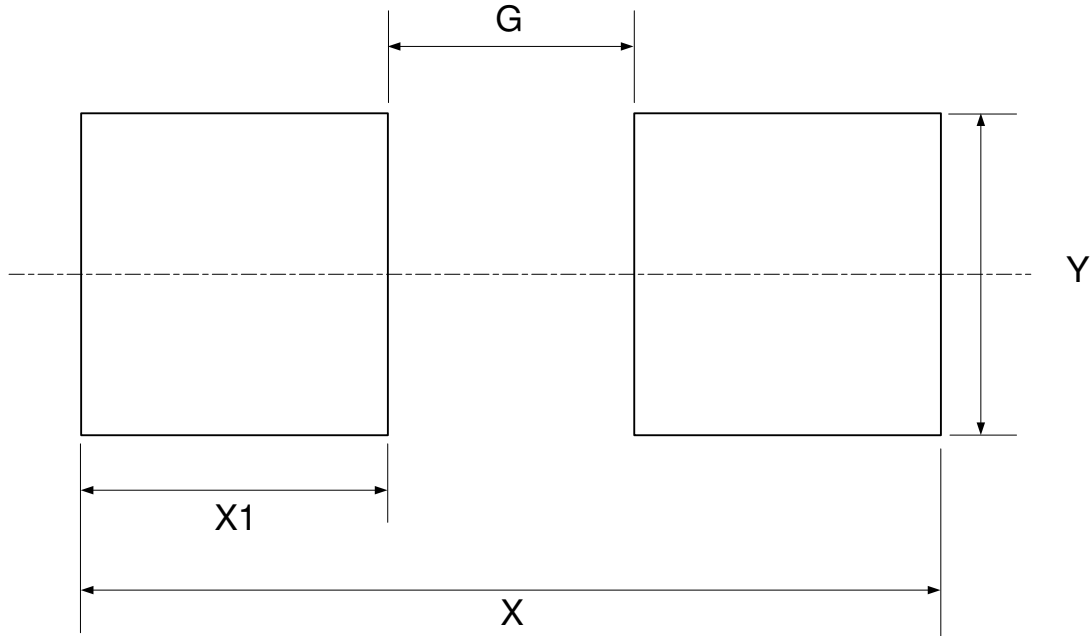
**Package Outline Dimensions** (All dimensions in mm(inch).)

(1) Package Type: DO-214AC



## Suggested Pad Layout

(1) Package Type: DO-214AC



Dimensions	Y (mm)/(inch)	X1 (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)
Value	2.100/0.083	2.000/0.079	1.600/0.063	5.600/0.220

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